

SAW duplexer for small cell LTE band 3

Series/type: B8018

Ordering code: B39182B8018P810

Date: March 24, 2016

Version: 2.3

© EPCOS AG 2016. Reproduction, publication and dissemination of this data sheet, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

Table of contents

1 Application	
2 <u>Features</u>	
3 <u>Package</u>	
4 Pin configuration	
5 Matching circuit.	
6 Characteristics	
7 Maximum ratings	
8 Transmission coefficients	
9 Reflection coefficients	
10 EVMs	
11 Packing material	
12 <u>Marking</u>	
13 Soldering profile	
14 Annotations	
15 Cautions and warnings	
Important notes.	24



SAW duplexer for small cell

1747.5/1842.5

Data sheet

1 Application

- Low-loss SAW duplexer for LTE smallcell systems (Band 3)
- Low insertion attenuation
- High power durability
- Industrial qualification
- Usable pass band 75 MHz
- Rx = Uplink = 1710-1785 MHz
- Tx = Downlink = 1805-1880 MHz

2 Features

- Package size 2.5±0.1 mm × 2.0±0.1 mm
- Package height 0.5 mm (max.)
- Approximate weight 1 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)



Figure 1: Picture of component with example of product marking.

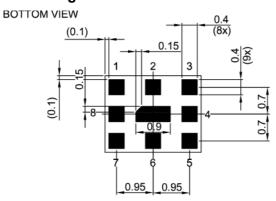


SAW duplexer for small cell

1747.5/1842.5

Data sheet

3 Package



4 Pin configuration

1 TX

■ 3 RX

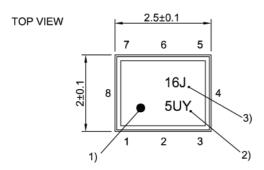
■ 6 ANT

■ 2, 4, 5, 7, Ground 8, 9

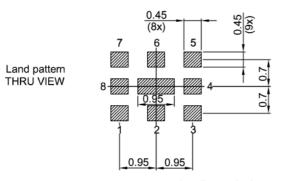
Pad and pitch tolerance ±0.05

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.5 mm (max.). See Sec. Package information (p. 23).

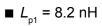


SAW duplexer for small cell

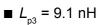
1747.5/1842.5

Data sheet

5 Matching circuit



■
$$L_{p6}$$
 = 3.6 nH



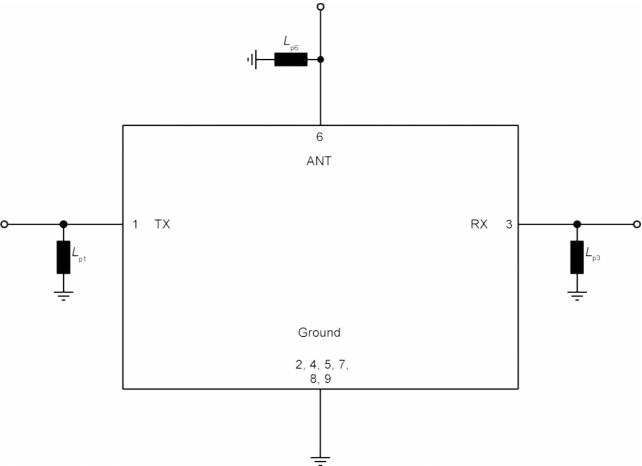


Figure 3: Schematic of matching circuit.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

6 Characteristics

6.1 TX – ANT

Temperature range for specification $T_{\rm SPEC} = -10~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with par. 8.2 nH $^{1)}$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 3.6 nH $^{1)}$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with par. 9.1 nH $^{1)}$

Characteristics TX – ANT				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	1842.5	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	1805 1880	MHz		_	2.6	4.0	dB
	1840 1870	MHz		_	1.7	2.5	dB
Amplitude ripple (p-p)			Δα				
	1805 1880	MHz		_	1.2	3.0	dB
	1840 1870	MHz		_	0.3	1.0	dB
Maximum VSWR			VSWR _{max}				
@ TX port	1805 1880	MHz		_	1.4	2.0	
@ ANT port	1805 1880	MHz		_	1.5	2.0	
Average error vector magnitude			EVM _{avg} ²⁾				
	1807.5 1877.5	MHz	9	_	1.6	3.5	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 1710	MHz		30	34	_	dB
	1710 1745	MHz		42	46	_	dB
	1745 1780	MHz		45	49	_	dB
	1780 1785	MHz		35	48	_	dB
	1900 1911	MHz		5	18	_	dB
	1911 1920	MHz		20	63	_	dB
	1920 1980	MHz		40	45	_	dB
	1980 2400	MHz		35	40	_	dB
	2400 2500	MHz		35	41	_	dB
	2500 3680	MHz		30	41	_	dB
	3680 3740	MHz		30	49	_	dB
	3740 5150	MHz		30	38	_	dB
	5150 5725	MHz		25	33	_	dB

¹⁾ See Sec. Matching circuit (p. 5).

Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

6.2 ANT - RX

Temperature range for specification $T_{\rm SPEC} = -10~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with par. 8.2 nH $^{1)}$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 3.6 nH $^{1)}$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with par. 9.1 nH $^{1)}$

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	1747.5	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	1710 1785	MHz		_	3.5	5.3	dB
	1745 1775	MHz		_	2.5	3.0	dB
Amplitude ripple (p-p)			Δα				
	1710 1785	MHz		_	2.2	4.0	dB
	1745 1775	MHz		_	1.0	1.5	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	1710 1785	MHz		_	1.6	2.0	
@ RX port	1710 1785	MHz		_	1.8	2.2	
Average error vector magnitude			EVM _{avg} ²⁾				
	1712.5 1782.5	MHz	· ·	_	2.5	4.0	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 1500	MHz		40	49	_	dB
	1500 1660	MHz		40	48	_	dB
	1660 1690	MHz		10	15	_	dB
	1805 1840	MHz		40	44	_	dB
	1840 1880	MHz		43	47	_	dB
	1880 2400	MHz		40	45	_	dB
	2400 2500	MHz		40	45	_	dB
	2500 3490	MHz		35	50	_	dB
	3490 3550	MHz		35	51	_	dB
	3500 5235	MHz		35	42	_	dB
	5235 5325	MHz		35	42	_	dB

¹⁾ See Sec. Matching circuit (p. 5).

²⁾ Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

6.3 TX – RX

Temperature range for specification $T_{\rm SPEC} = -10~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with par. 8.2 nH $^{1)}$ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 3.6 nH $^{1)}$ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with par. 9.1 nH $^{1)}$

Characteristics TX – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @+25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Minimum isolation			$\alpha_{_{min}}$				
	1710 1745	MHz		43	46	_	dB
	1745 1780	MHz		45	49	_	dB
	1780 1785	MHz		37	49	_	dB
	1805 1840	MHz		40	43	_	dB
	1840 1880	MHz		45	48	_	dB

¹⁾ See Sec. Matching circuit (p. 5).



SAW duplexer for small cell

1747.5/1842.5

Data sheet

7 **Maximum ratings**

Storage temperature	T _{STG} = -40 °C +85 °C	
DC voltage	$V_{DC} = 0 \text{ V (max.)}$	
ESD voltage	$V_{ESD} = 50 \text{ V (max.)}^{1)}$	
Input power	P _{IN}	
@ TX port: 1805 1880 MHz	27 dBm	Source and load impedance 50Ω. LTE 5MHz downlink. T=55°C, 50.000h.2)
@ TX port: 1805 1880 MHz	26 dBm	Source and load impedance 50Ω. LTE 5MHz downlink. T=55°C, 100.000h.2)
@ TX port: other frequency range(s)	10 dBm	Source and load impedance 50Ω .
Operating lifetime with output power at antenna	P _{OUT}	
@ ANT port: 1805 1880 MHz	21 dBm	Continuous wave T= 55 °C, 100khrs. ³⁾

According to JESD22-A115A (machine model), 1 negative and 1 positive pulses. Time to failure (TTF) according to accelerated power durability tests, and wear out models. 2)

According to accelerated high temperature operating life (HOTL) test.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

8 Transmission coefficients

8.1 TX – ANT

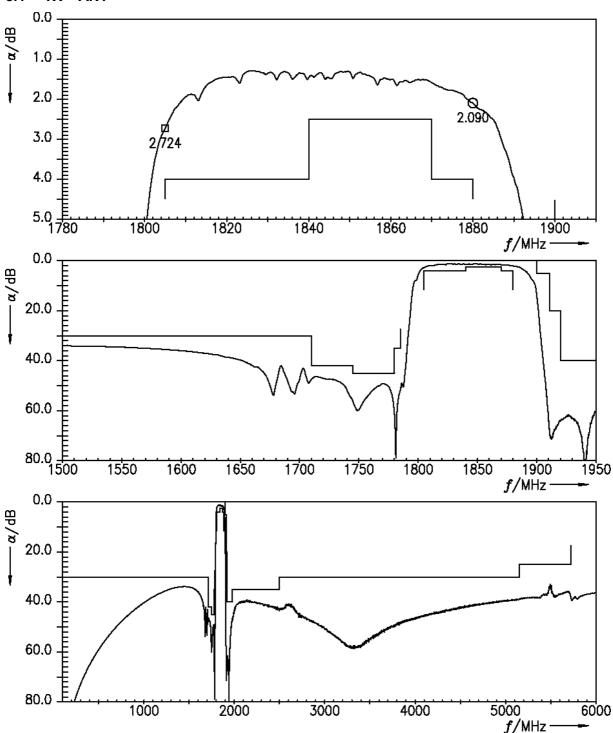


Figure 4: Attenuation TX – ANT.



SAW duplexer for small cell

1747.5/1842.5

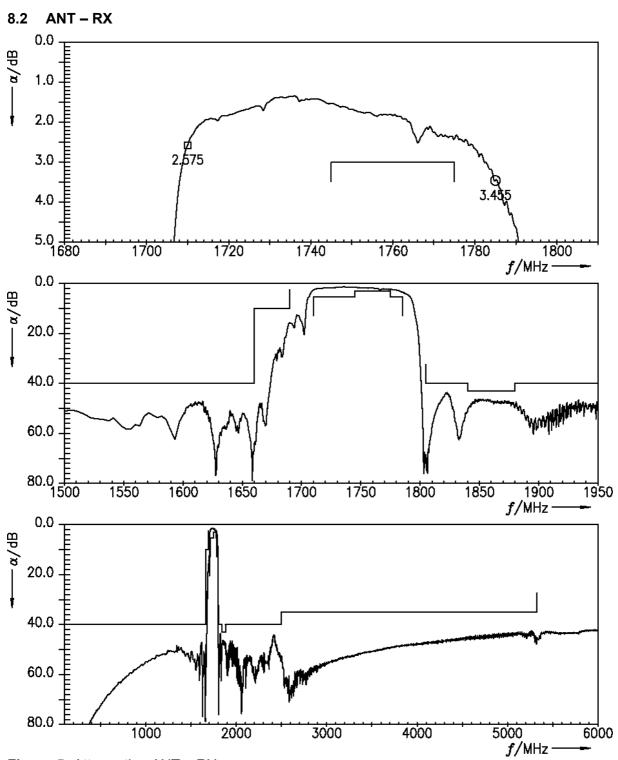


Figure 5: Attenuation ANT – RX.



SAW duplexer for small cell

1747.5/1842.5

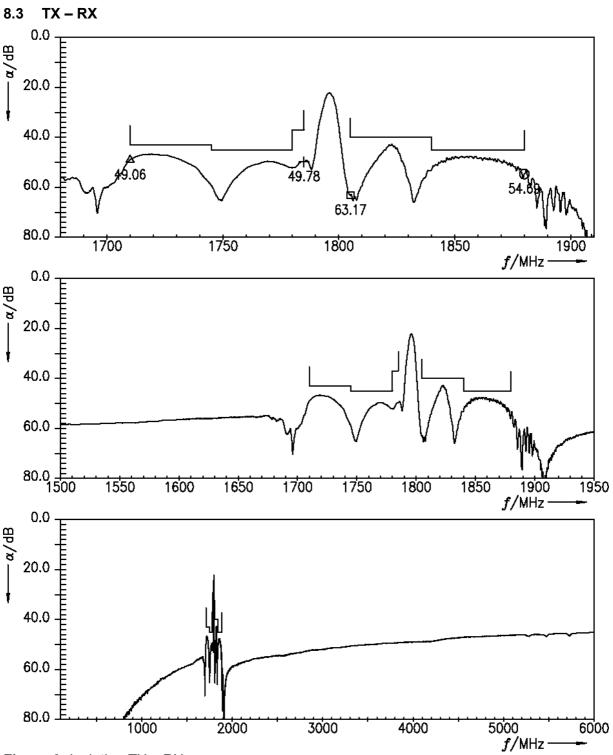


Figure 6: Isolation TX – RX.

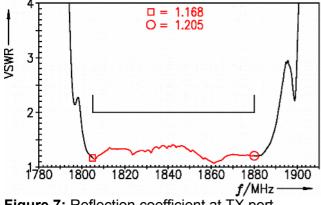


SAW duplexer for small cell

1747.5/1842.5

Data sheet

9 Reflection coefficients



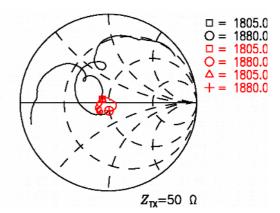
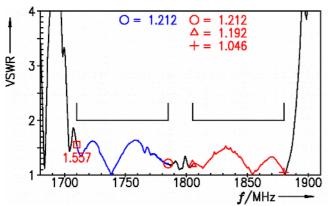


Figure 7: Reflection coefficient at TX port.



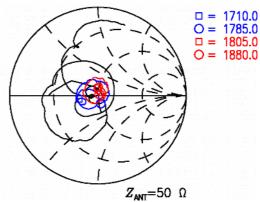
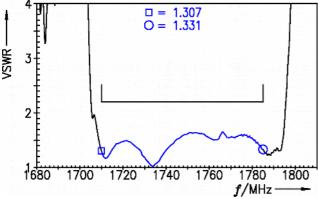


Figure 8: Reflection coefficient at ANT port (TX and RX frequencies).



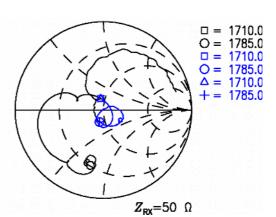


Figure 9: Reflection coefficient at RX port.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

10 EVMs

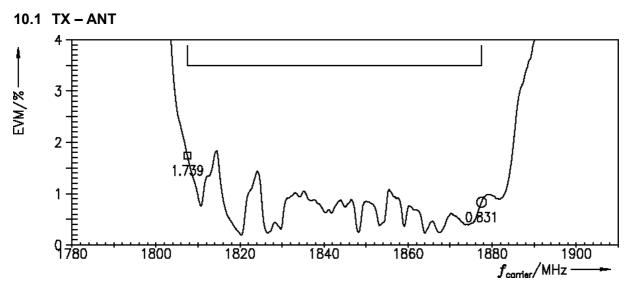


Figure 10: Error vector magnitude TX – ANT.



SAW duplexer for small cell

1747.5/1842.5

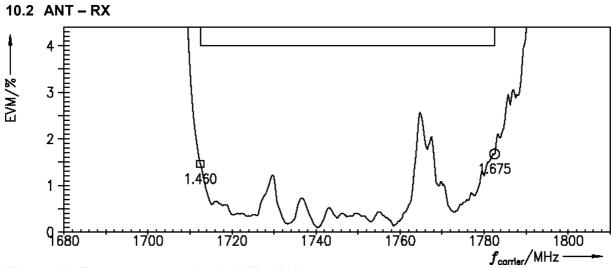


Figure 11: Error vector magnitude ANT – RX.



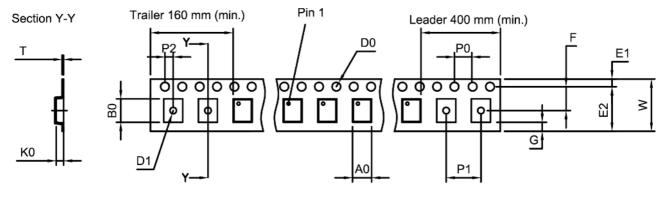
SAW duplexer for small cell

1747.5/1842.5

Data sheet

11 Packing material

11.1 Tape



User direction of unreeling

Figure 12: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	2.25±0.05 mm	E ₂	6.25 mm (min.)	P ₁	4.0±0.1 mm
B ₀	2.75±0.05 mm	F	3.5±0.05 mm	P ₂	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.25±0.03 mm
D ₁	1.0 mm (min.)	K	0.6±0.05 mm		8.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	Po	4.0±0.1 mm		

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm

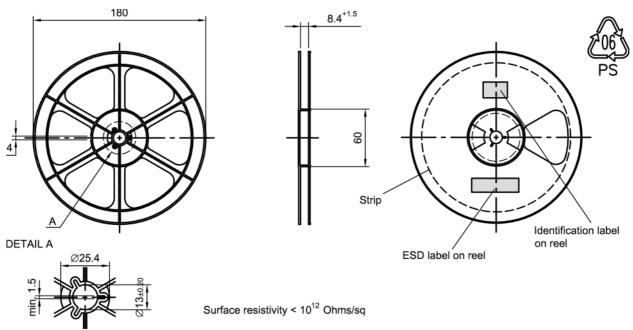


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.



SAW duplexer for small cell

1747.5/1842.5

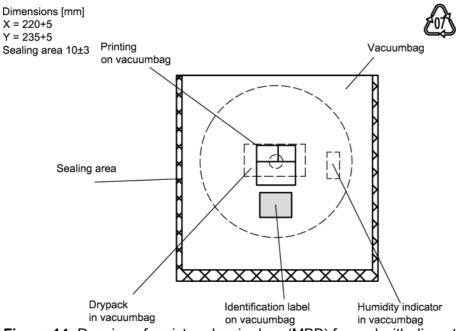


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

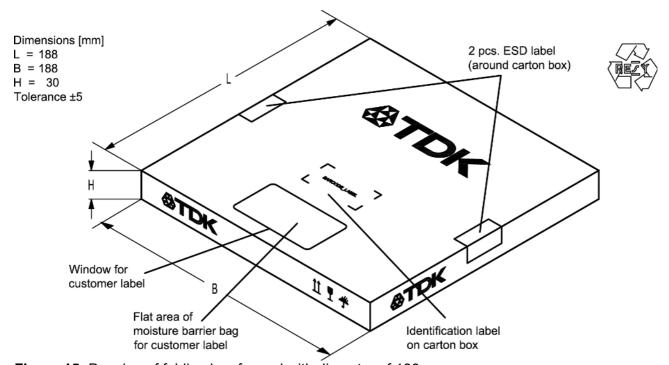


Figure 15: Drawing of folding box for reel with diameter of 180 mm.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

11.3 Reel with diameter of 330 mm

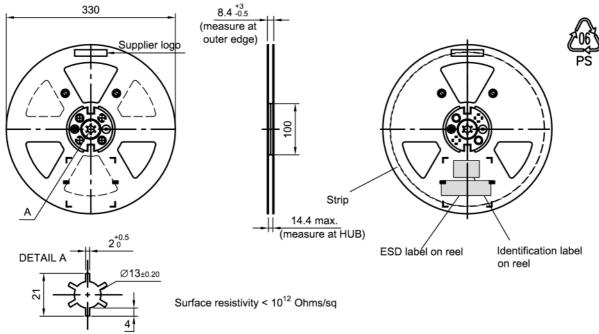


Figure 16: Drawing of reel (first-angle projection) with diameter of 330 mm.

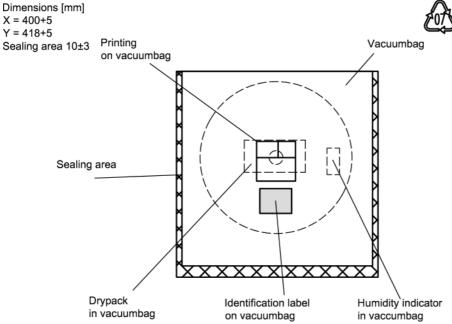


Figure 17: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

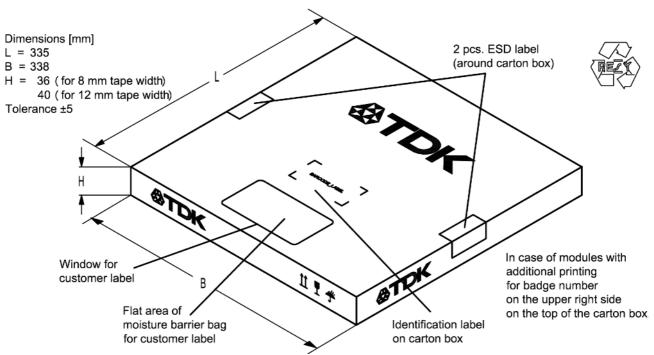


Figure 18: Drawing of folding box for reel with diameter of 330 mm.

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device

16J

1 x $32^2 + 6 \times 32^1 + 18 = 180 \times 32^0 = 180 \times 32$

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code. 5UY => 12345 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 = 12345$



SAW duplexer for small cell

1747.5/1842.5

Adopted BASE32 code for type number					
Decimal	Base32	Decimal	Base32		
value	code	value	code		
0	0	16	G		
1	1	17	Н		
2	2	18	J		
3	3	19	K		
4	4	20	M		
5	5	21	N		
6	6	22	Р		
7	7	23	Q		
8	8	24	R		
9	9	25	S		
10	Α	26	Т		
11	В	27	V		
12	С	28	W		
13	D	29	Х		
14	E	30	Y		
15	F	31	Z		

Adopted BASE47 code for lot number					
Decimal	Base47	Decimal	Base47		
value	code	value	code		
0	0	24	R		
1	1	25	S		
2	2	26	Т		
3	3	27	U		
4	4	28	V		
5	5	29	W		
6	6	30	X		
7	7	31	Y		
8	8	32	Z		
9	9	33	b		
10	Α	34	d		
11	В	35	f		
12	С	36	h		
13	D	37	n		
14	E	38	r		
15	F	39	t		
16	G	40	V		
17	Н	41	\		
18	J	42	?		
19	K	43	{		
20	L	44	}		
21	M	45	<		
22	N	46	>		
23	Р				

Table 2: Lists for encoding and decoding of marking.



SAW components

SAW duplexer for small cell

1747.5/1842.5

Data sheet

13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

≤ 3 K/s
125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
30 s to 70 s
min. 10 s
max. 20 s
_
250 °C +0/-5 °C
230 °C +5/-0 °C for 10 s ± 1 s
≤ 3 K/s
measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

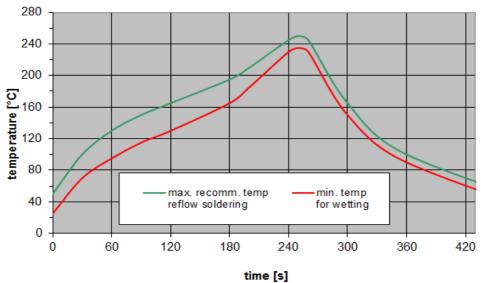


Figure 19: Recommended reflow profile for convection and infrared soldering – lead-free solder.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39182B8018P810	5000 pcs

Table 4: Ordering codes and packing units.



SAW duplexer for small cell

1747.5/1842.5

Data sheet

15 Cautions and warnings

15.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.
 - The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6. Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI).
- 7. The trade names EPCOS, Alu-X, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PQSine, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, TFAP, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.